

# SN74CBT162292

## 12-BIT 1-OF-2 FET MULTIPLEXER/DEMULTIPLEXER WITH INTERNAL PULLDOWN RESISTORS

SCDS052E – MARCH 1998 – REVISED OCTOBER 2000

- Member of Texas Instruments' Widebus™ Family
- TTL-Compatible Control Input Levels
- Isolation Under Power-Off Conditions
- Make-Before-Break Feature
- Internal 500-Ω Pulldown Resistors to Ground
- A-Port Inputs/Outputs Have Equivalent 25-Ω Series Resistors, So No External Resistors Are Required
- Latch-Up Performance Exceeds 250 mA Per JESD 17

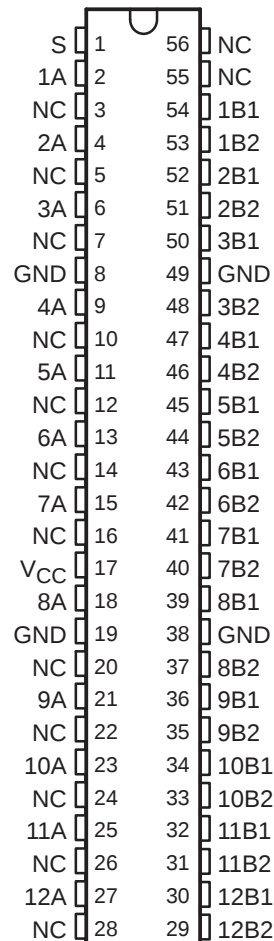
### description

The SN74CBT162292 is a 12-bit 1-of-2 high-speed TTL-compatible FET multiplexer/demultiplexer. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

When the select (S) input is low, port A is connected to port B1, and  $R_{INT}$  is connected to port B2. When S is high, port A is connected to port B2, and  $R_{INT}$  is connected to port B1.

The A-port inputs/outputs include equivalent 25-Ω series resistors to reduce overshoot and undershoot.

### DGG, DGV, OR DL PACKAGE (TOP VIEW)



NC – No internal connection

### ORDERING INFORMATION

| $T_A$         | PACKAGE†    |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|---------------|-------------|---------------|-----------------------|------------------|
| –40°C to 85°C | SSOP – DL   | Tube          | SN74CBT162292DL       | CBT162292        |
|               |             | Tape and reel | SN74CBT162292DLR      |                  |
|               | TSSOP – DGG | Tape and reel | SN74CBT162292DGGR     | CBT162292        |
|               | TVSOP – DGV | Tape and reel | SN74CBT162292DGVR     | CY2292           |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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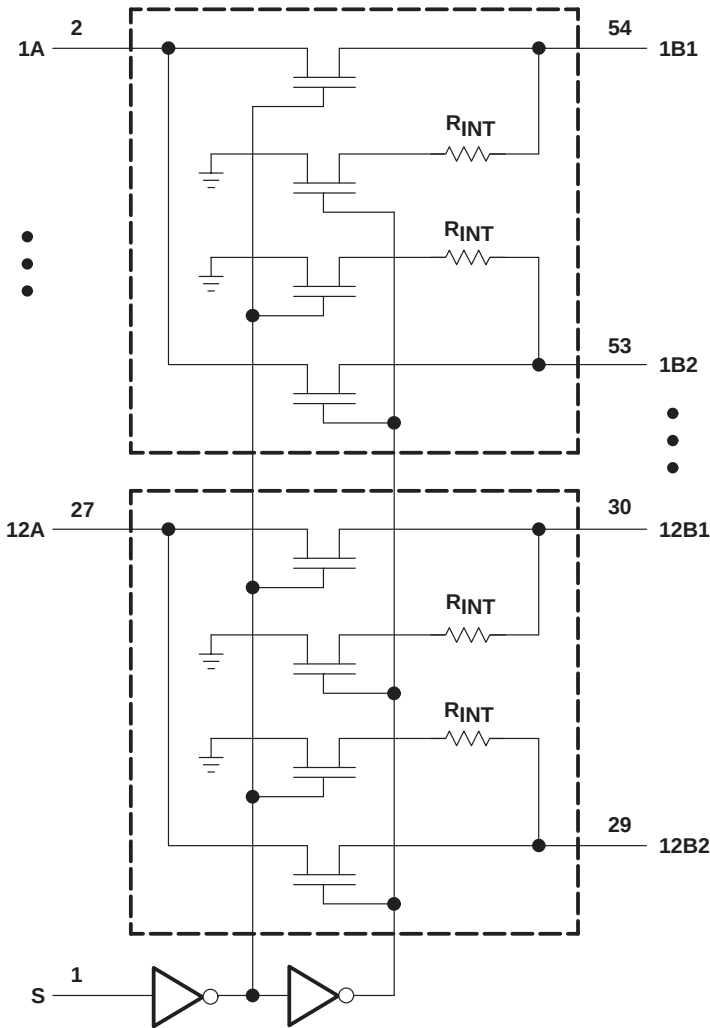
SN74CBT162292  
12-BIT 1-OF-2 FET MULTIPLEXER/DEMULTIPLEXER  
WITH INTERNAL PULLDOWN RESISTORS

SCDS052E – MARCH 1998 – REVISED OCTOBER 2000

FUNCTION TABLE

| INPUT<br>S | FUNCTION                                       |
|------------|------------------------------------------------|
| L          | A port = B1 port<br>R <sub>INT</sub> = B2 port |
| H          | A port = B2 port<br>R <sub>INT</sub> = B1 port |

logic diagram (positive logic)



## 3

**SN74CBT162292**  
**12-BIT 1-OF-2 FET MULTIPLEXER/DEMULTIPLEXER**  
**WITH INTERNAL PULLDOWN RESISTORS**

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**switching characteristics over recommended operating free-air temperature range,  $C_L = 50$  pF, (unless otherwise noted) (see Figure 1)**

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | $V_{CC} = 4$ V |      | $V_{CC} = 5$ V<br>$\pm 0.5$ V |      | UNIT |
|------------------|-----------------|----------------|----------------|------|-------------------------------|------|------|
|                  |                 |                | MIN            | MAX  | MIN                           | MAX  |      |
| $t_{pd}^\dagger$ | A or B          | B or A         |                | 1.9  |                               | 1.85 | ns   |
| $t_{en}$         | S               | A or B         | 1              | 10.7 | 1                             | 9.5  | ns   |
| $t_{dis}$        | S               | A or B         | 1              | 10.9 | 1                             | 9.7  | ns   |

<sup>†</sup> The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

**switching characteristics over recommended operating free-air temperature range,  $C_L = 50$  pF, (unless otherwise noted) (see Figure 1)**

| PARAMETER          | DESCRIPTION            | $V_{CC} = 4$ V |     | $V_{CC} = 5$ V<br>$\pm 0.5$ V |     | UNIT |
|--------------------|------------------------|----------------|-----|-------------------------------|-----|------|
|                    |                        | MIN            | MAX | MIN                           | MAX |      |
| $t_{mbb}^\ddagger$ | Make-before-break time | 0              | 2   | 0                             | 2   | ns   |

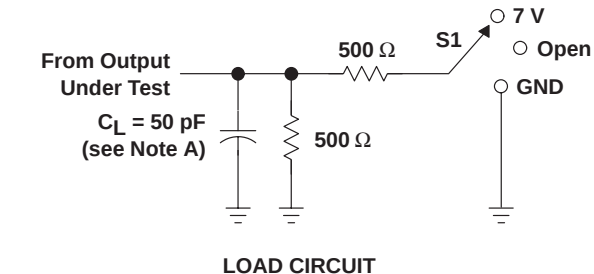
<sup>‡</sup> The make-before-break time is the time interval between make and break, during the transition from one selected port to the other.

# SN74CBT162292

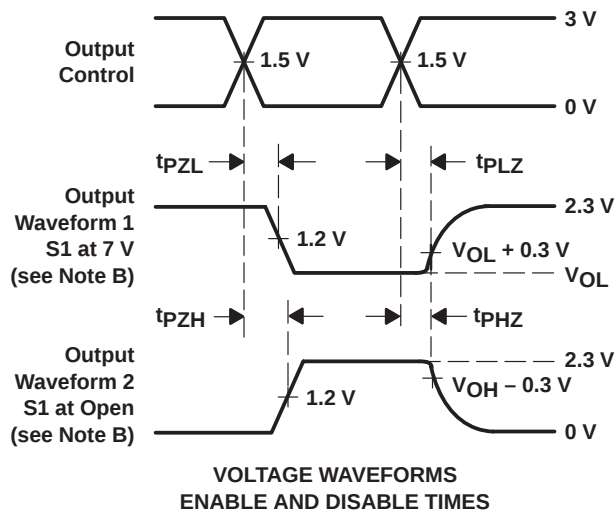
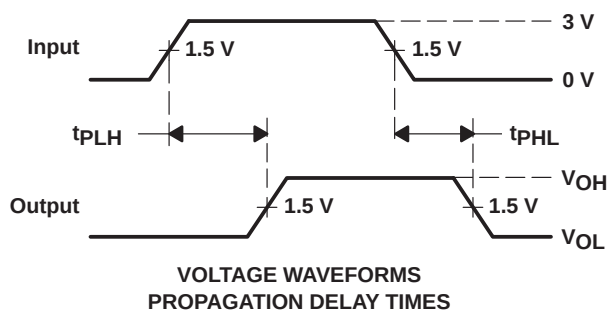
## 12-BIT 1-OF-2 FET MULTIPLEXER/DEMULTIPLEXER WITH INTERNAL PULLDOWN RESISTORS

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### PARAMETER MEASUREMENT INFORMATION



| TEST              | S1   |
|-------------------|------|
| $t_{pd}$          | Open |
| $t_{pZL}/t_{pLZ}$ | 7 V  |
| $t_{pZH}/t_{pHZ}$ | Open |



- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when connected to the internal 500- $\Omega$  pulldown resistor. Waveform 2 is for an output with internal conditions such that the output is high except when connected to the internal 500- $\Omega$  pulldown resistor.
  - All pulse inputs and DC inputs are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
  - The outputs are measured one at a time with one transition per measurement.
  - $t_{pLZ}$  and  $t_{pHZ}$  are the same as  $t_{dis}$ .  $Z = R_{INT} = 500 \Omega$ .
  - $t_{pZL}$  and  $t_{pZH}$  are the same as  $t_{en}$ .  $Z = R_{INT} = 500 \Omega$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 1. Load Circuit and Voltage Waveforms

## PACKAGING INFORMATION

| Orderable part number             | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">SN74CBT162292DGGR</a> | Active        | Production           | TSSOP (DGG)   56 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | CBT162292           |
| SN74CBT162292DGGR.A               | Active        | Production           | TSSOP (DGG)   56 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | CBT162292           |
| <a href="#">SN74CBT162292DL</a>   | Active        | Production           | SSOP (DL)   56   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | CBT162292           |
| SN74CBT162292DL.A                 | Active        | Production           | SSOP (DL)   56   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | CBT162292           |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

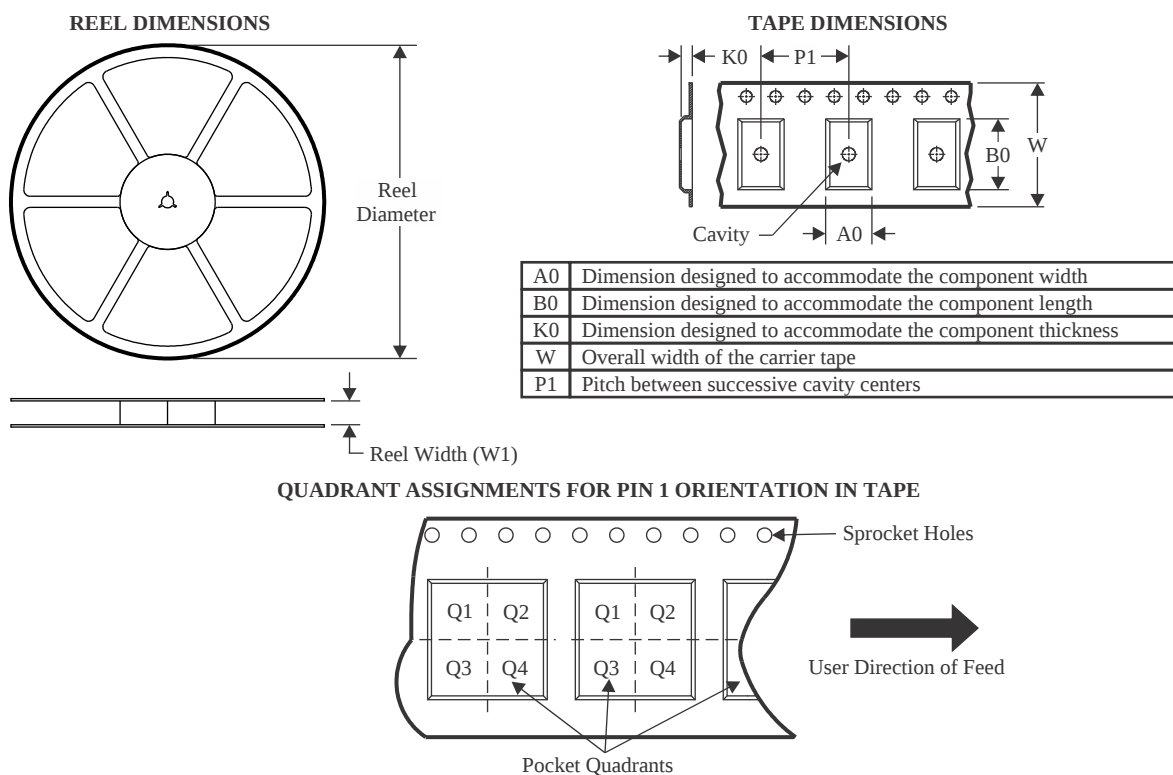
<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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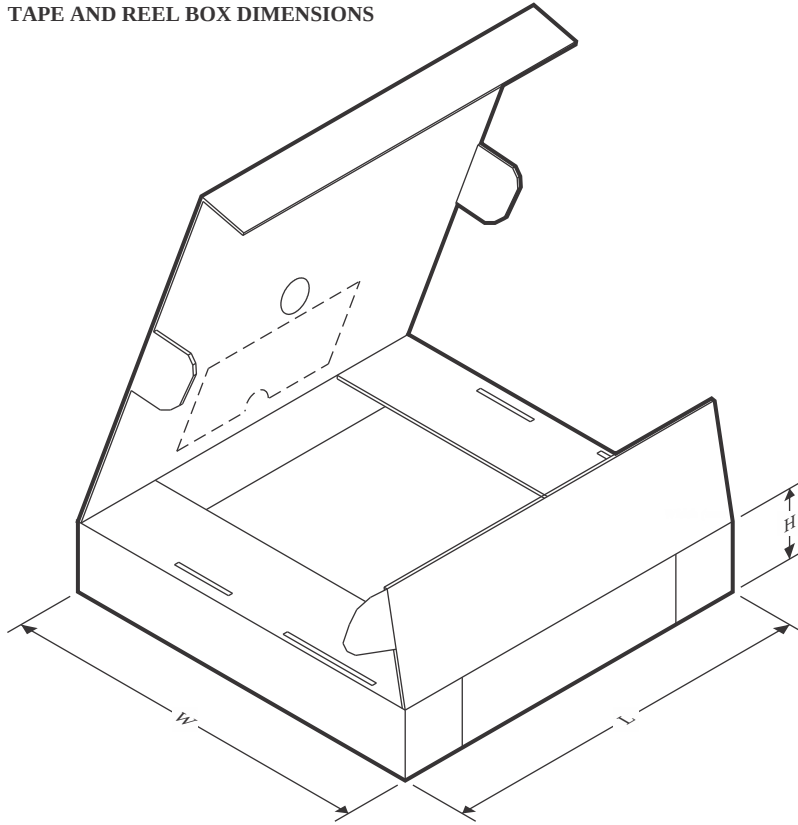
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74CBT162292DGGR | TSSOP        | DGG             | 56   | 2000 | 330.0              | 24.4               | 8.9     | 14.7    | 1.4     | 12.0    | 24.0   | Q1            |

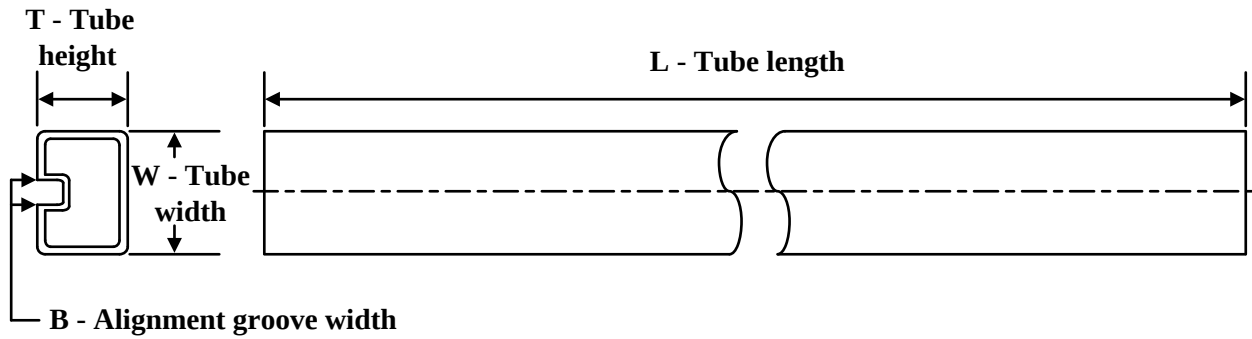
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74CBT162292DGGR | TSSOP        | DGG             | 56   | 2000 | 356.0       | 356.0      | 45.0        |

## TUBE

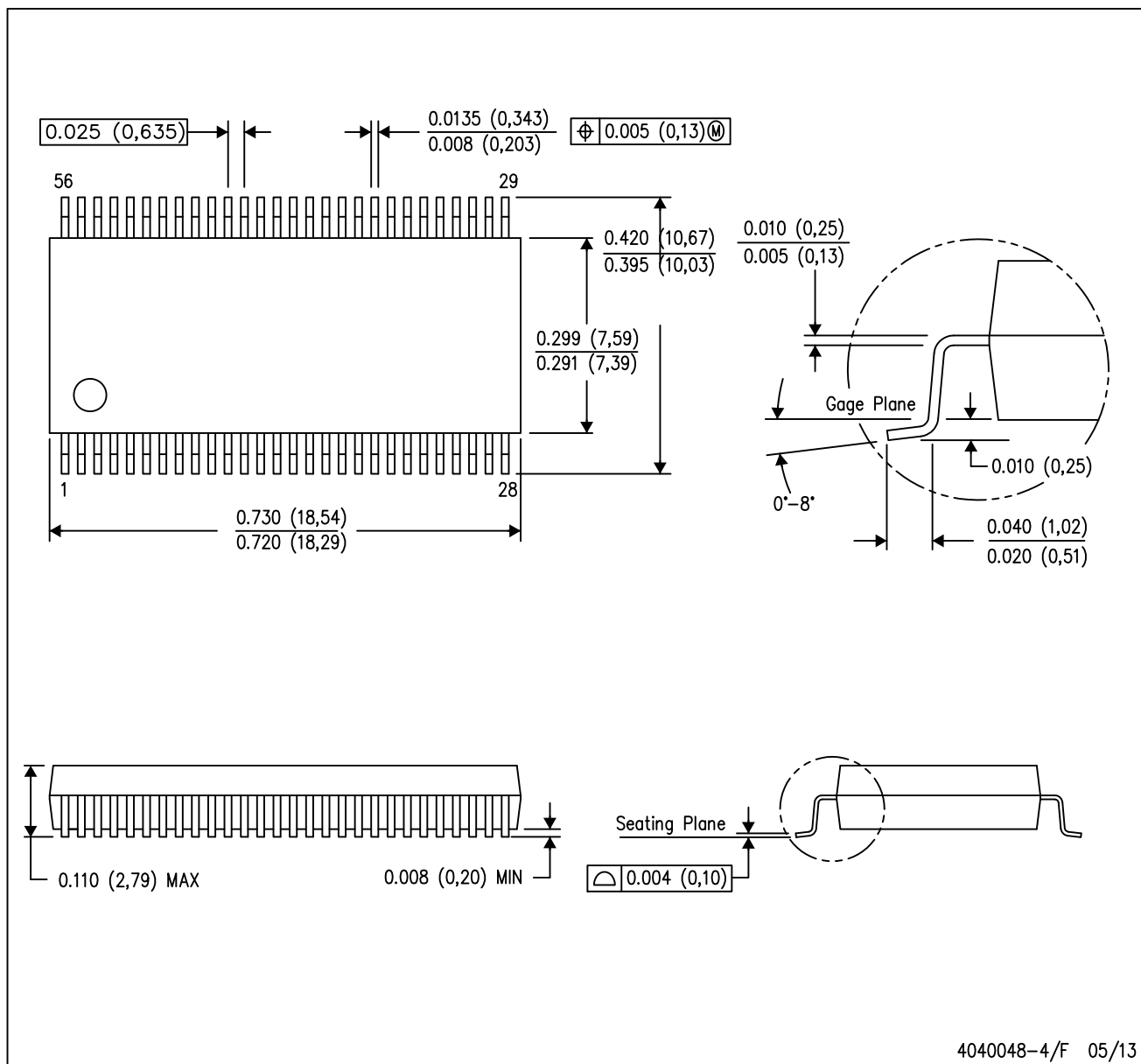


\*All dimensions are nominal

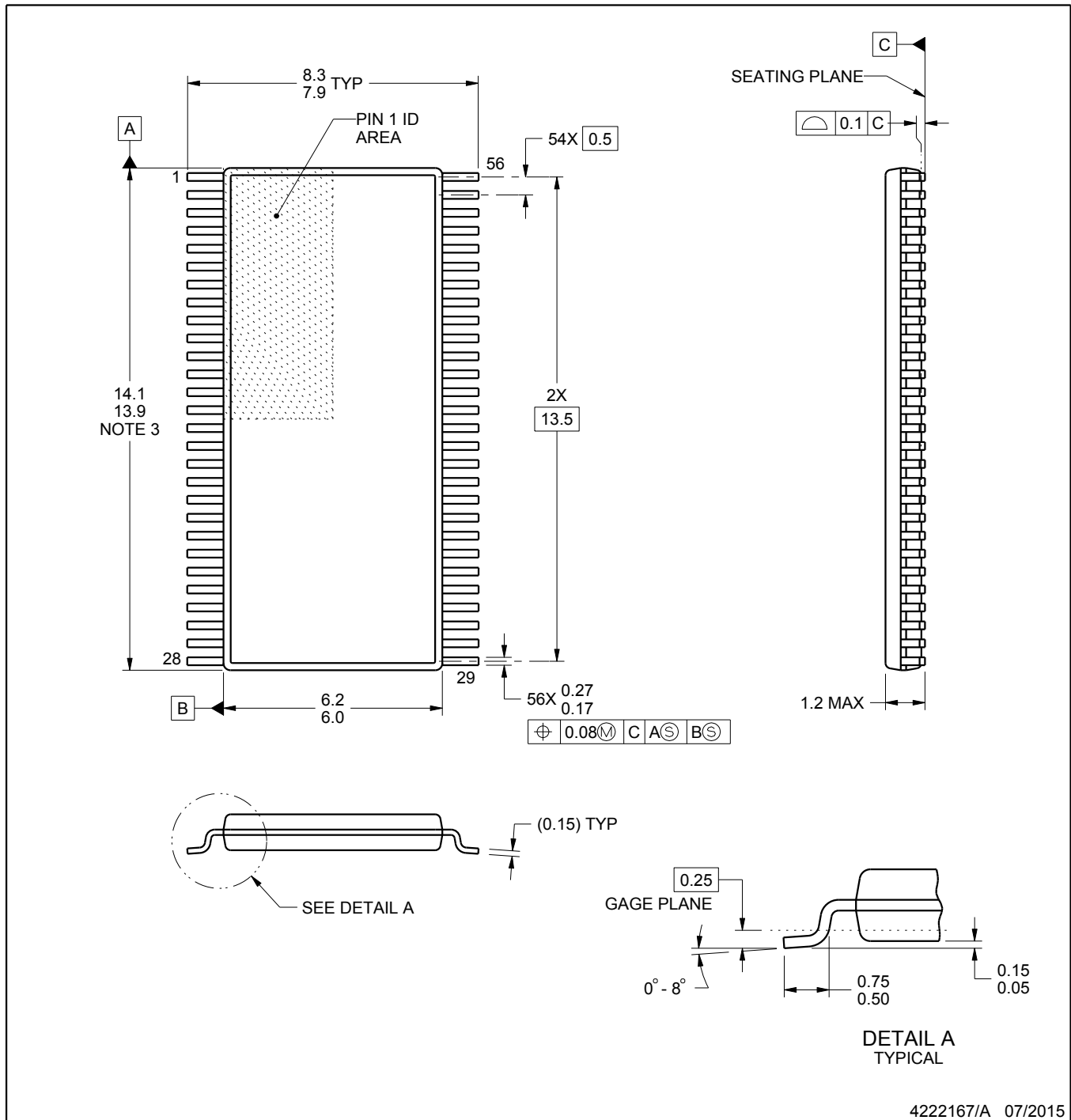
| Device            | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74CBT162292DL   | DL           | SSOP         | 56   | 20  | 473.7  | 14.24  | 5110   | 7.87   |
| SN74CBT162292DL.A | DL           | SSOP         | 56   | 20  | 473.7  | 14.24  | 5110   | 7.87   |

DL (R-PDSO-G56)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed  $0.006$  (0,15).
  - D. Falls within JEDEC MO-118



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## NOTES:

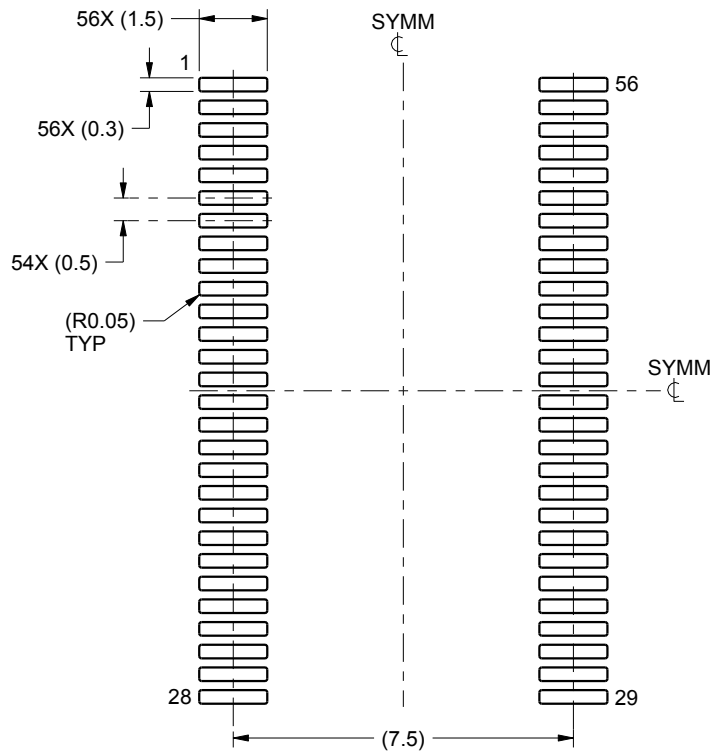
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

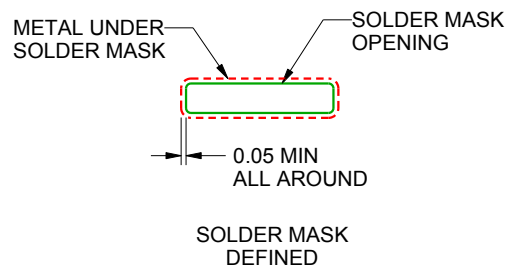
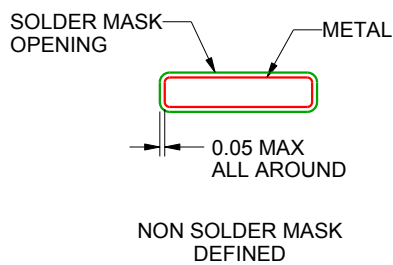
DGG0056A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

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NOTES: (continued)

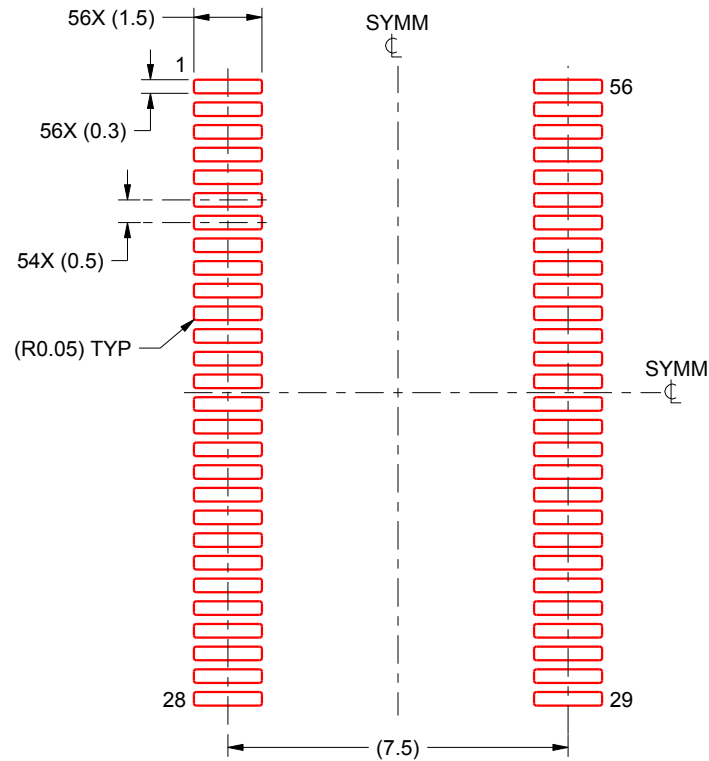
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DGG0056A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

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NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

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